# **P-Channel Enhancement-Mode MOSFET Transistors**

### **Product Summary**

Part Number	V <sub>(BR)DSS</sub> Min (V)	V <sub>GS(th)</sub> (V)	r <sub>DS(on)</sub> Max (Ω)	I <sub>D(on)</sub> Min (mA)	C <sub>rss</sub> Max (pF)	t <sub>ON</sub> Typ (ns)
3N163	-40	-2 to -5	250	-5	0.7	18
3N164	-30	-2 to -5	300	-3	0.7	18

#### **Features**

### **Benefits**

- Ultra-Low Input Leakage: 0.02 pA Typ. High Input Impedance Isolation
- High Gate Breakdown Voltage: ±125 V Minimize Handling ESD Problems
- Normally Off

- High Off Isolation without Power

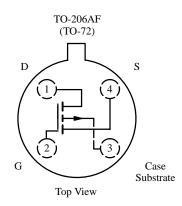
### Applications

- Ultra-High Input Impedance Amplifier
- Smoke Detectors
- Electrometers
- Analog Switching
- Digital Switching

### **Description**

The 3N163/164 are lateral p-channel MOSFETs designed for analog switch and preamplifier applications where high speed and low parasitic capacitances are required.

The hermetic TO-206AF package is compatible with military processing per military standards (see Military information).



## Absolute Maximum Ratings ( $T_A = 25^{\circ}C$ Unless Otherwise Noted)

Drain-Source Voltage	(3N164)30 V	Storage Temperature       -65 to 200°C         Operating Junction Temperature       -55 to 150°C         Power Dissipation <sup>a</sup> 375 mW					
Continuous Drain Current	50 mA	Notes:					
	rom case for 10 seconds) 300°C						

Updates to this data sheet may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #70228.

# 3N163/3N164

# **Specifications**<sup>a</sup>

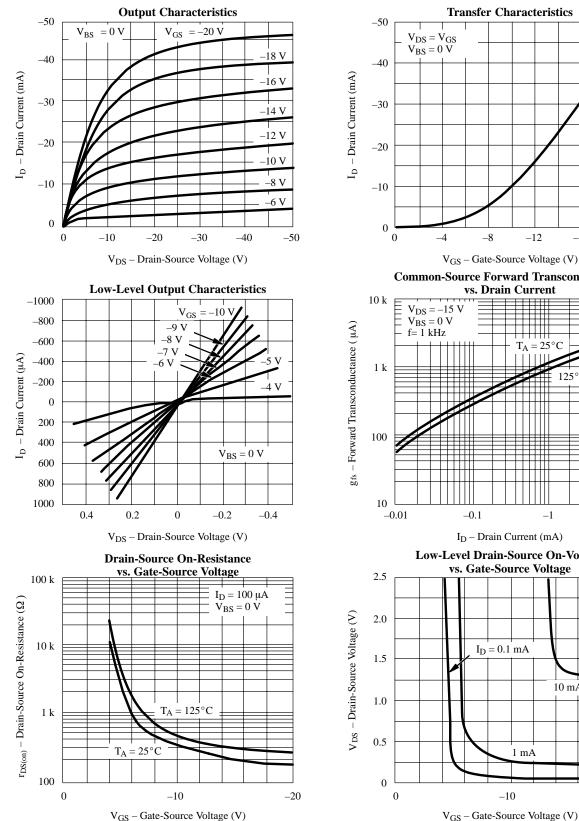
		Test Conditions		Typ <sup>b</sup>	Limits				
					3N163		3N164		1
Parameter	Symbol				Min	Max	Min	Max	Unit
Static	•	•				•		•	
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$I_D = -10 \ \mu A, \ V_{DS} = 0 \ V$		-70	-40		-30		v
Source-Drain Breakdown Voltage	V <sub>(BR)SDS</sub>	$I_S = -10 \ \mu\text{A}, \ V_{GD} = V_{BD} = 0 \ V$		-70	-40		-30		
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$I_D = -10 \ \mu A, \ V_{GS} = V_{DS}$		-2.5	-2	-5	-2	-5	
Gate-Source Voltage	V <sub>GS</sub>	$I_D = -0.5 \text{ mA}, V_{DS} = -15 \text{ V}$		-3.5	-3	-6.5	-2.5	-6.5	
	I <sub>GSS</sub>	$V_{GS} = -40 \text{ V},$	$V_{DS} = 0 V$	<-1		-10			
			$T_A = 125^\circ C^d$	-1					1
Gate-Body Leakage		$V_{GS} = -30 V,$	$V_{DS} = 0 V$	<-1				-10	pА
			$T_A = 125^\circ C^d$	-1					1
		$V_{\rm DS} = -15  \rm V,$	$V_{GS} = 0 V$	-8		-200		-400	1
Zero-Gate Voltage Drain Current	I <sub>DSS</sub>		$T_A = 125^{\circ}C^d$	-20					nA
	I <sub>SDS</sub>	$V_{GD} = V_{BD} = 0 V$	$V, V_{SD} = -20 V$	-10		-400		-800	pА
Zero-Gate Voltage Source Current			$T_A = 125^{\circ}C^d$	-25					nA
On-State Drain Current <sup>c</sup>	I <sub>D(on)</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}$		-10	-5	-30	-3	-30	mA
	r <sub>DS(on)</sub>	$V_{GS} = -20 \text{ V}, \text{ I}_{I}$	$D = -100 \ \mu A$	180		250		300	Ω
Drain-Source On-Resistance			$T_A = 125^\circ C^d$	270					
Dynamic									
Forward Transconductance <sup>c</sup>	gfs	$V_{DS} = -15$ V, $I_D = -10$ mA f = 1 kHz		2.7	2	4	1	4	mS
Common-Source Output Conductance <sup>c</sup>	g <sub>os</sub>			150		250		250	μS
Input Capacitance	C <sub>iss</sub>	$V_{DS} = -15 \text{ V}, I_D = -10 \text{ mA}$ $f = 1 \text{ MHz}$		2.4		3.5		3.5	pF
Output Capacitance	C <sub>oss</sub>			2.5		3		3	
Reverse Transfer Capacitance	C <sub>rss</sub>			0.5		0.7		0.7	
Switching <sup>e</sup>	-	•			-		-	•	<u> </u>
	t <sub>d(on)</sub>	$\begin{split} V_{DD} &= -15 \text{ V},  \text{R}_L = 1500 \ \Omega \\ I_D &\cong -10 \text{ mA},  \text{V}_{GEN} = -12 \text{ V} \\  \text{R}_G &= 50 \ \Omega \end{split}$		5		12		12	ns
Turn-On Time	tr			13		24		24	
Turn-Off Time	t <sub>d(off)</sub>			25		50		50	

Notes:

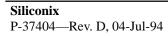
a. T<sub>A</sub> = 25°C unless otherwise noted.
b. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
c. Pulse test: PW ≤ 300 µs duty cycle ≤ 3%.

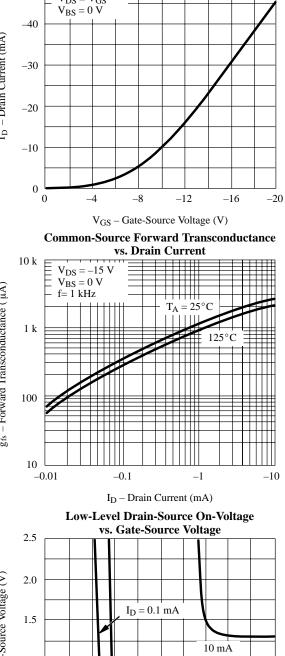
d. This parameter not registered with JEDEC.e. Switching time is essentially independent of operating temperature.

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## **Typical Characteristics**



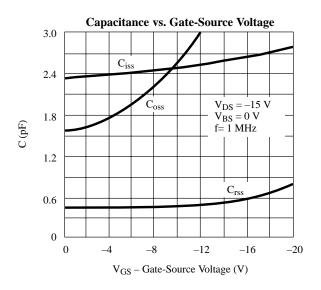


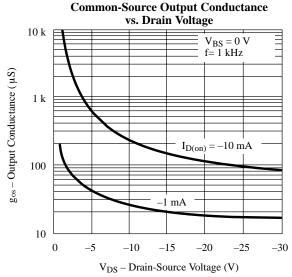
1 mA

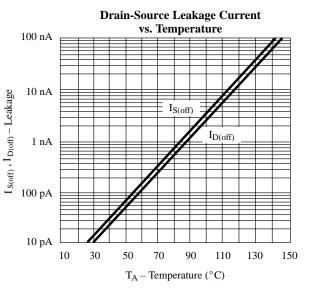
-10

-20

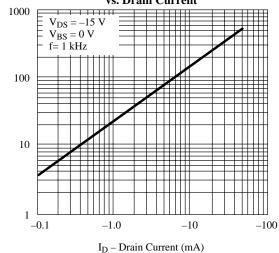
# **Typical Characteristics (Cont'd)**



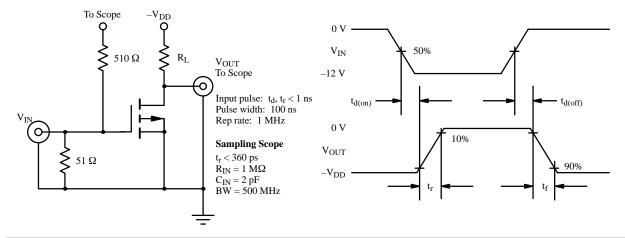




Common-Source Output Conductance vs. Drain Current



### Switching Time Test Circuit



 $g_{os}$  – Output Conductance ( $\mu S$ )



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